7 Channel DC/DC Converters

General Description

The RT9917 is a complete power-supply solution for digital still cameras and other hand-held devices.

It integrates:

CH1: Boost DC-DC converter with load disconnect controller (SW1).

CH2: Selectable Boost/Buck DC-DC converter

CH3: Step-down DC-DC converter with internal compensation.

CH4 : Step-down DC-DC converter with internal compensation.

CH5: DC/DC converter with HV NMOS, internal compensation and load disconnect (SW5) for CCD positive supply.

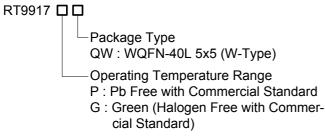
CH6: DC/DC converter with HV PMOS for CCD negative supply.

CH7: WLED driver with HV NMOS, internal compensation and allow for PWM dimming.

SW1: Load disconnect controller for CH1.

SW5: Load disconnect switch for CH5.

Ordering Information



Note:

Richtek Pb-free and Green products are :

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

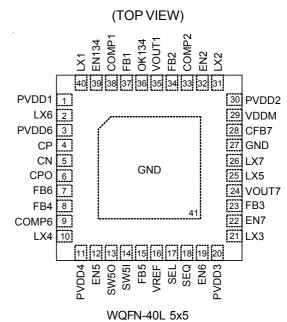
Features

- 1 Channel Boost/Buck Selectable by SEL Pin
- 2 Selectable On/Off Sequence Set by SEQ Pin
- 4 Channels with Internal Compensation
- Provide Charge Pump Voltage to Enhance NMOS Gate Driving Capability for Alkaline Battery Input
- All Power Switches Integrated
- Syn Step-Down DC/DC Converter
 - ▶ Up to 95% Efficiency
 - ▶ 100% (MAX) Duty Cycle
- Syn Step-Up DC/DC Converter
 - ▶ Adjustable Output Voltage
 - ▶ Up to 95% Efficiency
- Open LED Protection
- Transformerless Inverting Converter for CCD
- Fixed 1MHz Switching Frequency
- Compact 40-Lead WQFN Package
- RoHS Compliant and 100% Lead (Pb)-Free

Applications

- Digital Still Camera
- PDA
- Portable Device

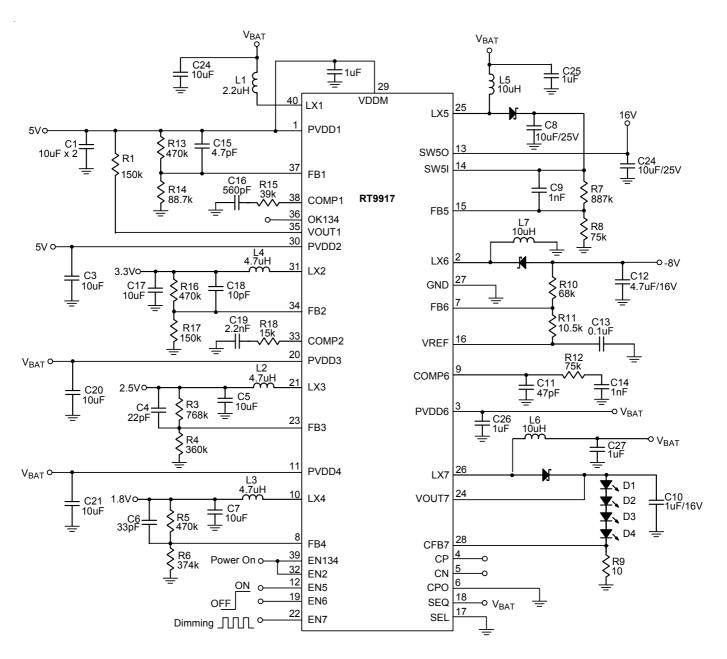
Pin Configurations





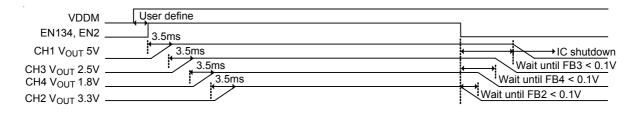
Typical Application Circuit

For Li-ion : CH2 3.3V is from V_{OUT} of CH1

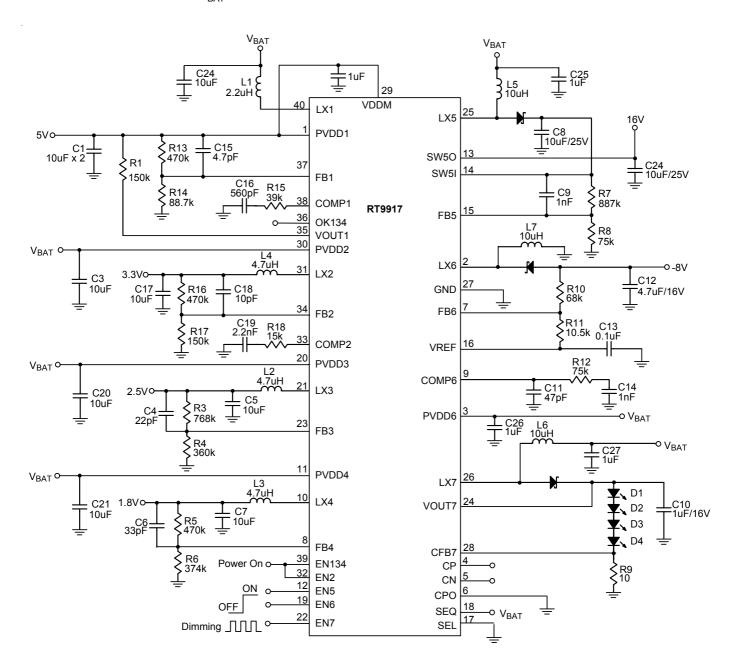


Timing Diagram

Power On Sequence : CH1 Boost $5V \rightarrow CH3$ Buck $2.5V \rightarrow CH4$ Buck $1.8V \rightarrow CH2$ Buck 3.3V Power Off Sequence : CH2 Buck $3.3V \rightarrow CH4$ Buck $1.8V \rightarrow CH3$ Buck $2.5V \rightarrow CH1$ Boost 5V

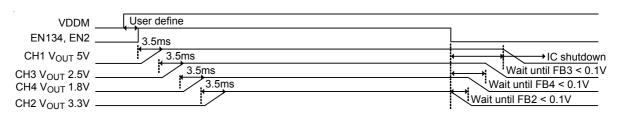


For Li-ion : CH2 3.3V is from V_{BAT}



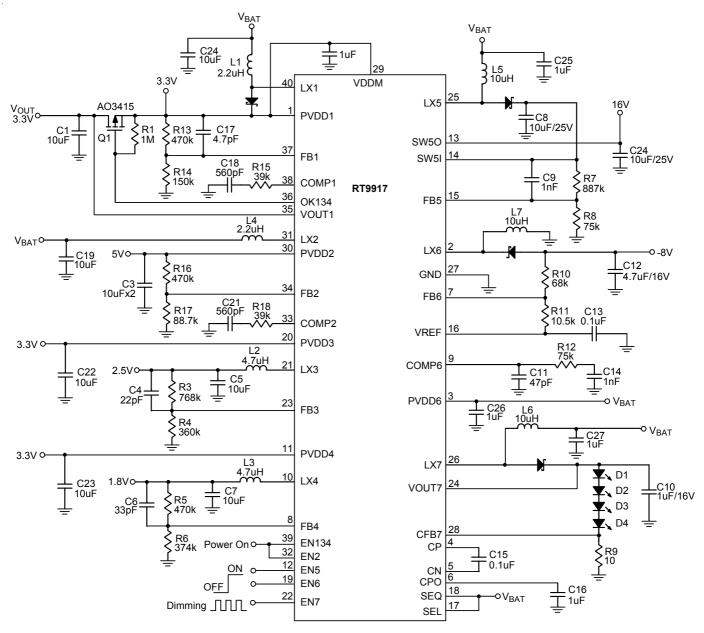
Timing Diagram

Power On Sequence : CH1 Boost $5V \rightarrow CH3$ Buck $2.5V \rightarrow CH4$ Buck $1.8V \rightarrow CH2$ Buck 3.3V Power Off Sequence : CH2 Buck $3.3V \rightarrow CH4$ Buck $1.8V \rightarrow CH3$ Buck $2.5V \rightarrow CH1$ Boost 5V





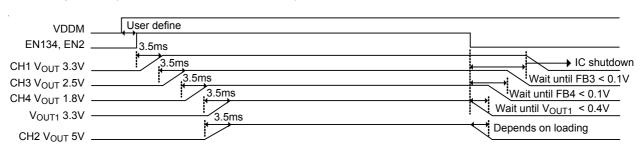
For 2AA



Note: A schottky diode connect from LX1 to PVDD1 is required for low-voltage start up.

Timing Diagram

Power On Sequence : CH1 Boost 3.3V \rightarrow CH3 Buck 2.5V \rightarrow CH4 Buck 1.8V \rightarrow (CH2 Boost 5V and SW1 3.3V) Power Off Sequence : (CH2 Boost 5V and SW1 3.3V) \rightarrow CH4 Buck 1.8V \rightarrow CH3 Buck 2.5V \rightarrow CH1 Boost 3.3V





Channel		CH3					
Formula		V _{OUT} = (1+R3/R4) x 0.8					
V _{OUT} (V)	2.5	1.8	1.3	1.2	1.0		
L(uH)	4.7	4.7	4.7	4.7	4.7		
R3(kΩ)	768	470	237	187	23.2		
R4(kΩ)	360	374	374	374	93.1		
C4(pF)	22	33	68	82	47		
C _{OUT} (uF)	10	10	10	10	10		

Channel		CH4						
Formula		V _{OUT} = (1+R5/R6) x 0.8						
V _{OUT} (V)	2.5	1.8	1.3	1.2	1.0			
L(uH)	4.7	4.7	4.7	4.7	4.7			
R5(kΩ)	768	470	237	187	23.2			
R6(kΩ)	360	374	374	374	93.1			
C6(pF)	22	33	68	82	47			
C _{OUT} (uF)	10	10	10	10	10			

Channel	CH5							
Formula		V _{OUT} = (1+R7/R8) x 1.25						
V _{OUT} (V)	12	13	15	15.5	16			
L(uH)	10	10	10	10	10			
R7(kΩ)	820	820	1000	820	886			
R8(kΩ)	95.3	86.6	90.9	71.5	75			
C9(pF)	1000	1000	1000	1000	1000			
C _{OUT} (uF)	10/16V	10/16V	10/25V	10/25V	10/25V			

Channel		CH6					
Formula	Vo	_{DUT} = (R10/R1	1)*(-1.25)	* R10+R11 <	90k		
V _{OUT} (V)	-6	-6.3	-7	-7.5	-8		
L(uH)	10	10	10	10	10		
R10(kΩ)	57.6	69.8	63.4	68	68		
R11(kΩ)	12	13.7	11.3	11.3	10.5		
C _{OUT} (uF)	10/16V	10/16V	4.7/16V	4.7/16V	4.7/16V		
R12(kΩ)	47	47	75	75	75		
C11(pF)	47	47	47	47	47		
C14(pF)	1000	1000	1000	1000	1000		

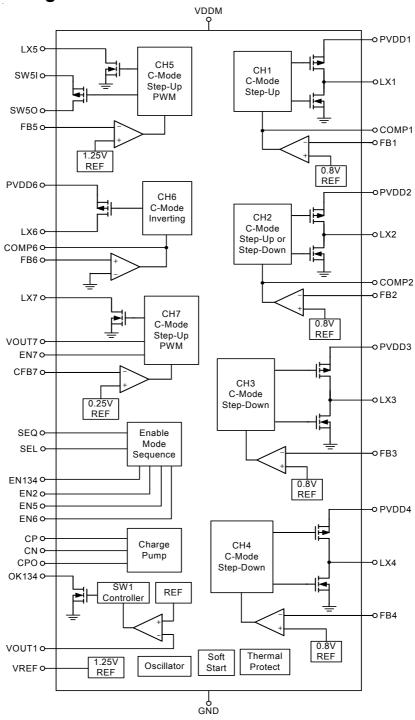


Functional Pin Description

Pin No.	Pin Name	Pin Function
1	PVDD1	Power Input Pin for CH1.
2	LX6	Switch Node of CH6. High impedance in shutdown.
3	PVDD6	Power Input Pin for CH6.
4	CP	·
	_	Charge Pump External Driver Pin.
5	CN	Charge Pump External Driver Pin.
6	CPO	Output Pin for Charge Pump.
7	FB6	Feedback Input Pin for CH6. High impedance in shutdown.
8	FB4	Feedback Input Pin for CH4. High impedance in shutdown.
9	COMP6	Compensation Pin for CH6. Pull to GND in shutdown.
10	LX4	Switch Node for CH4. High impedance in shutdown.
11	PVDD4	Power Input Pin for CH4.
12	EN5	Enable Pin for CH5.
13	SW5O	Output Pin for CH5 Load Disconnect.
14	SW5I	Input Pin for CH5 Load Disconnect.
15	FB5	Feedback Input Pin for CH5. High impedance in shutdown.
16	VREF	1.25V Reference Output Pin.
17	SEL	CH2 Boost/Buck Select Pin. Logic state can't be changed during operation.
18	SEQ	CH1, CH3, CH4 Power On/Off Sequence Setting Pin. Logic state can't be changed during operation.
19	EN6	Enable Pin for CH6.
20	PVDD3	Power Input Pin for CH3
21	LX3	Switch Node for CH3. High impedance in shutdown.
22	EN7	Enable Pin for CH7.
23	FB3	Feedback Input Pin for CH3. High impedance in shutdown.
24	VOUT7	Sense Pin for CH7 Output Voltage.
25	LX5	Switch Node for CH5. High impedance in shutdown.
26	LX7	Switch Node for CH7. High impedance in shutdown.
27,	GND	Analog GND Pin. The exposed pad must be soldered to a large PCB and
41 (Exposed Pad)		connected to GND for maximum thermal dissipation.
28	CFB7	Feedback Input Pin for CH7.
29	VDDM	IC analog Input Power Pin. This voltage is also used to drive power NMOS gate of CH5 and CH7.
30	PVDD2	Power Input Pin for CH2.
31	LX2	Switch Node for CH2. High impedance in shutdown.
32	EN2	Enable Pin for CH2
33	COMP2	Compensation Pin for CH2
34	FB2	Feedback Input Pin for CH2. High impedance in shutdown.
35	VOUT1	Sense Pin for CH1 Output Voltage. High impedance in shutdown.
36	OK134	External Switch Control Pin. High impedance in shutdown.
37	FB1	Feedback Input Pin for CH1. High impedance in shutdown.
38	COMP1	Compensation Pin for CH1. Pull to GND in shutdown.
39	EN134	Enable Pin for CH1, CH3, CH4, SW1.
40	LX1	Switch Node for CH1. High impedance in shutdown.

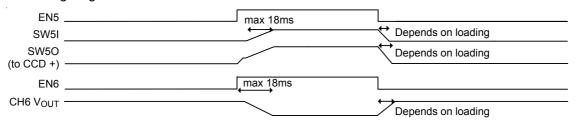


Function Block Diagram



Timing Diagram

CH5 and CH6 Timing Diagram





Absolute Maximum Ratings (Note 1)

5	
• Supply Voltage, V _{DDM}	0.3V to 7V
• Power Input PVDD1, PVDD2, PVDD3, PVDD4, PVDD6	
Switch node:	
LX1, LX2, LX3, LX4	
LX5, LX7, SW5I, SW5O, VOUT7	
LX6	(PVDD6 – 14V) to (PVDD6 + 0.3V)
• The Other Pins	
• Power Dissipation, P _D @ T _A = 25°C	
WQFN 40L 5x5	2.778W
Package Thermal Resistance (Note 4)	
WQFN 40L 5x5, θ_{JA}	36°C/W
WQFN 40L 5x5, θ_{JC}	7°C/W
Junction Temperature	150°C
• Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	
• ESD Susceptibility (Note 2)	
HBM (Human Body Mode)	2kV
MM (Machine Mode)	200V
Recommended Operating Conditions (Note 3)	

- Supply Voltage, V_{DDM} ------ 2.7V to 5.5V
- EN7 Dimming Control Frequency Range for CH7 ------ 1kHz to 100kHz

(avoid 2k to 20kHz for audio noise)

Electrical Characteristics

 $(V_{DDM} = 3.3V. T_A = 25^{\circ}C. unless otherwise specified)$

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Supply Voltage						
VDDM Minimum Startup Voltage	V _{ST}				1.6	V
VDDM Over Voltage Protection			5.6	6	6.5	V
VDDM Over Voltage Protection					0.6	V
Hysteresis			-		0.6	
Supply Current						
Shutdown Supply Current into VDDM	I _{OFF}	EN134 = EN2 = EN5 = EN6 = EN7 = 0V		1	10	uA
CH1 (Syn-Boost) + SW1 : Supply Current into VDDM	I _{Q1}	Non Switching, EN134 = 3.3V			800	uA
CH2 (Syn-Boost or Syn-Buck) : Supply Current into VDDM	I _{Q2}	Non Switching, EN2 = 3.3V	1		800	uA
CH3 (Syn-Buck) : Supply Current into VDDM	I _{Q3}	Non Switching, EN134 = 3.3V			800	uA

To be continued



CH4 (Syn-Buck): Supply Current into VDDM	Parameter	Symbol	Test Condition	Min	Тур	Max	Units	
Supply Current into VDDM	CH4 (Syn-Buck):		Non Switching, EN134 =			000		
Supply Current into VDDM	Supply Current into VDDM	I _{Q4}	3.3V			800	uA	
Supply Current into VDDM	CH5 (Asyn-Boost) + SW5 :		N 0 " 1 " ENE 0 0 "			000	•	
Supply Current into VDDM	Supply Current into VDDM	I _{Q5}	Non Switching, EN5 = 3.3V			800	uA	
Supply Current into VDDM	CH6 (Inverting) + Charge pump		Non Switching, EN6 = 3.3V			000		
Supply Current into VDDM	Supply Current into VDDM	IQ6	PVDD6 = 3.3V			800	uA	
Supply Current into VDDM	CH7 (WLED):		Non Curitohing FN7 = 2 21/			900		
CH1,2,3,4,5,6,7 Operating Frequency foSC 900 1000 1100 kHz CH1 Maximum Duty Cycle (Boost) VFB1 = 0.7V 80 83 86 % CH2 Maximum Duty Cycle (Boost) VFB2 = 0.7V 80 83 86 % CH2 Maximum Duty Cycle (Buck) VFB2 = 0.7V 100 % CH3 Maximum Duty Cycle (Buck) VFB3 = 0.7V 100 % CH4 Maximum Duty Cycle (Buck) VFB3 = 0.7V 100 % CH4 Maximum Duty Cycle (Boost) VFB3 = 1.15V 91 94 97 % CH5 Maximum Duty Cycle (Inverting) VFB6 = 1.15V 91 94 97 % CH6 Maximum Duty Cycle (WLED) CFB7 = 0.15V 91 94 97 % CH6 Maximum Duty Cycle (Inverting) VFB6 = 0.1V 91 94 97 % CH6 Maximum Duty Cycle (Inverting) VFB7 = 0.15V 91 94 97 % CH6 Maximum Duty Cycle (McD0 CRE6 = 0.1V 91	Supply Current into VDDM	IQ7	Non Switching, EN7 = 3.3V			800	uA	
CH1 Maximum Duty Cycle (Boost) V _{FB1} = 0.7V 80 83 86 % CH2 Maximum Duty Cycle (Boost) V _{FB2} = 0.7V 80 83 86 % CH2 Maximum Duty Cycle (Buck) V _{FB2} = 0.7V 100 % CH3 Maximum Duty Cycle (Buck) V _{FB3} = 0.7V 100 % CH4 Maximum Duty Cycle (Buck) V _{FB3} = 0.7V 100 % CH5 Maximum Duty Cycle (Boost) V _{FB4} = 0.7V 100 % CH6 Maximum Duty Cycle (Inverting) V _{FB5} = 1.15V 91 94 97 % CH6 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % CH6 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % CH6 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % Feedback Regulation Voltage FB1 0.788 0.8 0.812 V Feedback Regulation Voltage @ FB5 1.237 1	Oscillator							
CH2 Maximum Duty Cycle (Boost) V _{FB2} = 0.7V 80 83 86 % CH2 Maximum Duty Cycle (Buck) V _{FB2} = 0.7V 100 % CH3 Maximum Duty Cycle (Buck) V _{FB3} = 0.7V 100 % CH4 Maximum Duty Cycle (Buck) V _{FB3} = 0.7V 100 % CH5 Maximum Duty Cycle (Buck) V _{FB6} = 0.1V 100 % CH6 Maximum Duty Cycle (Buck) V _{FB6} = 1.15V 91 94 97 % CH6 Maximum Duty Cycle (Inverting) V _{FB6} = 0.1V 91 94 97 % CH6 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % CH7 Maximum Duty Cycle (Buck) C _{FB7} = 0.15V 91 94 97 % CH7 Maximum Duty Cycle (Buck) C _{FB7} = 0.15V 91 94 97 % Feedback Regulation Voltage @ FB6 0.15 0.7 1.237 1.25 1.263 V Feedback Reg	CH1,2,3,4,5,6,7 Operating Frequency	fosc		900	1000	1100	kHz	
CH2 Maximum Duty Cycle (Buck) V _{FB2} = 0.7V 100 % CH3 Maximum Duty Cycle (Buck) V _{FB3} = 0.7V 100 % CH4 Maximum Duty Cycle (Boost) V _{FB5} = 0.7V 100 % CH5 Maximum Duty Cycle (Inverting) V _{FB6} = 0.1V 91 94 97 % CH6 Maximum Duty Cycle (Inverting) V _{FB6} = 0.1V 91 94 97 % CH6 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % CH7 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % CH7 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % CH7 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % Feedback Regulation Voltage CFB7 0.15V 91 94 97 % Feedback Regulation Voltage & FB6 1.237 1.25 1.263 V Feedback Regulation Voltage & FB6 0.8134 = 1V	CH1 Maximum Duty Cycle (Boost)		V _{FB1} = 0.7V	80	83	86	%	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	CH2 Maximum Duty Cycle (Boost)		V _{FB2} = 0.7V	80	83	86	%	
CH4 Maximum Duty Cycle (Buck) V _{FB4} = 0.7V 100 % CH5 Maximum Duty Cycle (Boost) V _{FB5} = 1.15V 91 94 97 % CH6 Maximum Duty Cycle (Inverting) V _{FB6} = 0.1V 91 94 97 % CH7 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % Feedback Regulation Voltage FB1, FB2, FB3, FB4 0.788 0.8 0.812 V Feedback Regulation Voltage @ FB5 0.788 0.8 0.812 V Feedback Regulation Voltage @ FB6 -15 0 15 mV Feedback Regulation Voltage @ FB6 -15 0 15 mV Feedback Regulation Voltage @ FB6 -15 0 15 mV Feedback Regulation Voltage @ FB6 -15 0 15 mV Feedback Regulation Voltage @ FB6 -15 0 15 mV Feedback Regulation Voltage @ FB6 -15 0 15 mV Ferstance State Regulation Voltage @ FB6 -15	CH2 Maximum Duty Cycle (Buck)		V _{FB2} = 0.7V			100	%	
CH5 Maximum Duty Cycle (Boost) V _{FBS} = 1.15V 91 94 97 % CH6 Maximum Duty Cycle (Inverting) V _{FBS} = 0.1V 91 94 97 % CH7 Maximum Duty Cycle (WLED) C _{FB7} = 0.15V 91 94 97 % Feedback Regulation Voltage FB5 0.788 0.8 0.812 V Feedback Regulation Voltage @ FB5 1.237 1.25 1.263 V Feedback Regulation Voltage @ FB6 -15 0 15 mV Feedback Regulation Voltage @ CFB7 0.237 0.25 0.263 V Feedback Regulation Voltage @ CFB7 OK134 = 1V 140 uA Reference VREF OK134 = 1V 140 uA VREF Load Regulation VREF OµA < I _{REF} < 200µA	CH3 Maximum Duty Cycle (Buck)		V _{FB3} = 0.7V			100	%	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	CH4 Maximum Duty Cycle (Buck)		V _{FB4} = 0.7V			100	%	
CH7 Maximum Duty Cycle (WLED) CFB7 = 0.15V 91 94 97 %	CH5 Maximum Duty Cycle (Boost)		V _{FB5} = 1.15V	91	94	97	%	
Feedback Regulation Voltage @ FB1, FB2, FB3, FB4 0.788 0.8 0.812 V	CH6 Maximum Duty Cycle (Inverting)		V _{FB6} = 0.1V	91	94	97	%	
Feedback Regulation Voltage @ FB1, FB2, FB3, FB4 0.788 0.8 0.812 V	CH7 Maximum Duty Cycle (WLED)		C _{FB7} = 0.15V	91	94	97	%	
FB2, FB3, FB4	Feedback Regulation Voltage							
FB2, FB3, FB4	Feedback Regulation Voltage @ FB1,			0.700	0.8	0.912	\ \	
Feedback Regulation Voltage @ FB6 -15 0 15 mV Feedback Regulation Voltage @ CFB7 0.237 0.25 0.263 V OK134 Sink Current OK134 = 1V 140 uA Reference VREF Output Voltage VREF 1.237 1.25 1.263 V VREF Load Regulation 0μA < I _{REF} < 200μA	FB2, FB3, FB4			0.766	0.6	0.012	V	
Feedback Regulation Voltage @ CFB7 0.237 0.25 0.263 V OK134 Sink Current OK134 = 1V 140 uA Reference VREF Output Voltage VREF 1.237 1.25 1.263 V VREF Load Regulation 0μA < I _{REF} < 200μA	<td>Feedback Regulation Voltage @ FB5</td> <td></td> <td></td> <td>1.237</td> <td>1.25</td> <td>1.263</td> <td>V</td>	Feedback Regulation Voltage @ FB5			1.237	1.25	1.263	V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Feedback Regulation Voltage @ FB6			-15	0	15	mV	
Reference VREF Output Voltage VREF 1.237 1.25 1.263 V VREF Load Regulation 0μA < I _{REF} < 200μA	Feedback Regulation Voltage @ CFB7			0.237	0.25	0.263	V	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	OK134 Sink Current		OK134 = 1V		140		uA	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Reference							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	VREF Output Voltage	V_{REF}		1.237	1.25	1.263	V	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	VREF Load Regulation		0μA < I _{REF} < 200μA			10	mV	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Power Switch							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	OLIA OL BASISTANA A MODELL	_	P-MOSFET, PVDD1 = 3.3V		150		mΩ	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	CH1 On Resistance of MOSFET	R _{DS(ON)}	N-MOSFET, PVDD1 = 3.3V		150		mΩ	
	CH1 Current Limitation (Boost)		•		3		Α	
			·					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	CH2 On Resistance of MOSFET	R _{DS(ON)}						
	CH2 Current Limitation (Buck)							
CH3 On Resistance of MOSFET $ R_{DS(ON)} = \frac{P-MOSFET, PVDD3 = 3.3V}{N-MOSFET, PVDD3 = 3.3V} - \frac{200}{} = \frac{m\Omega}{m\Omega} $								
CH3 On Resistance of MOSFET $R_{DS(ON)}$ $N-MOSFET$, $PVDD3 = 3.3V$ 200 $m\Omega$			•					
	CH3 On Resistance of MOSFET	R DS(ON)						
	CH3 Current Limitation (Buck)							

To be continued

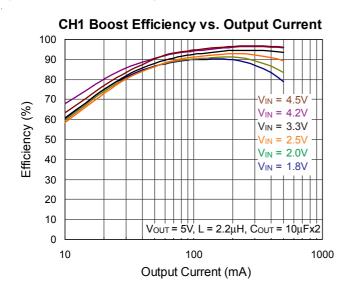


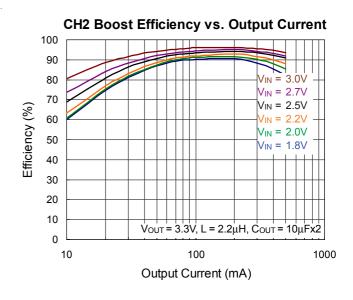
Parameter	Symbol	Test Condition	Min	Тур	Max	Units
OLIA O. D		P-MOSFET, PVDD4 = 3.3V		200		mΩ
CH4 On Resistance of MOSFET	R _{DS(ON)}	N-MOSFET, PVDD4 = 3.3V		200	_	mΩ
CH4 Current Limitation (Buck)		P-MOSFET, PVDD4 = 3.3V		1.5		Α
CH5 Load Disconnect MOSFET		P-MOSFET, SW5I = 3.3V		0.5		Ω
CH5 On Resistance of MOSFET		N-MOSFET, VDDM = 3.3V		0.5	_	Ω
CH5 Current Limitation		N-MOSFET, VDDM = 3.3V		1.5	-	Α
CH6 On Resistance of MOSFET		P-MOSFET, PVDD6 = 3.3V		1		Ω
CH6 Current Limitation		P-MOSFET, PVDD6 = 3.3V		1.5		Α
CH7 On Resistance of MOSFET		N-MOSFET, VDDM = 3.3V		0.5	-	Ω
CH7 Current Limitation		N-MOSFET, VDDM = 3.3V		0.8	_	Α
Protection	•					
Over Voltage Protection of PVDD1				6		V
Over Voltage Protection of PVDD2				6	_	V
Under Voltage Protection of VOUT1				1.75		V
Over Voltage Protection of SW5I				19	_	V
Over Voltage Protection of VOUT7			_	19	_	V
CH5 Load Disconnect UVP of SW5O				0.4		V
Control						•
EN134, EN2, EN5, EN6, EN7 Input					4.0	.,
High Level Threshold				0.8	1.3	V
EN134, EN2, EN5, EN6, EN7 Input			0.4			.,
Low Level Threshold			0.4	0.8		V
EN134, EN2, EN5, EN6, EN7 Sink				0		
Current				2	6	uA
SEQ SEL Input High Level Threshold			1.3		_	V
SEQ SEL Input Low Level Threshold					0.4	V
SEQ SEL Sink Current		EN134 or EN2 or EN5 or EN6 or EN7 = 3.3V	-	6	18	uA
SEQ SEL Sink Current		EN134 = EN2 = EN5 = EN6 = EN7 = 0V		0	0.1	uA
Thermal Protection						
Thermal Shutdown	T _{SD}		125	160	_	°C
Thermal Shutdown Hysteresis	ΔT _{SD}			20		°C

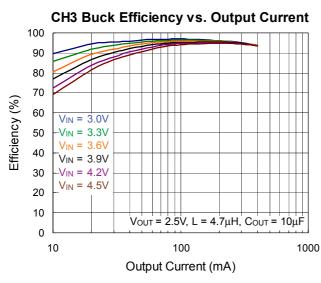
- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2. Devices are ESD sensitive. Handling precaution is recommended.
- **Note 3.** The device is not guaranteed to function outside its operating conditions.
- **Note 4.** θ_{JA} is measured in the natural convection at $T_A = 25^{\circ}C$ on a high effective four layers thermal conductivity test board of JEDEC 51-7 thermal measurement standard.

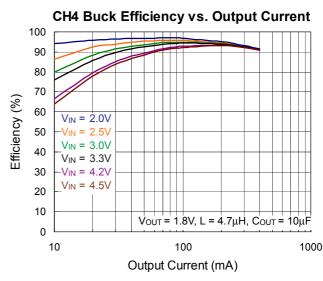


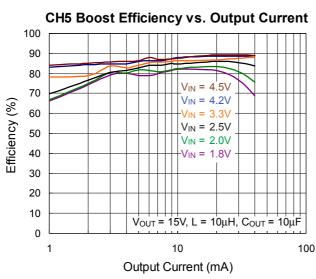
Typical Operating Characteristics

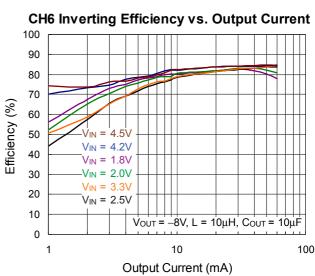




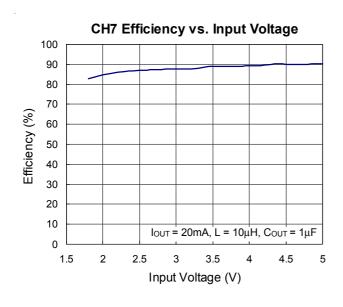


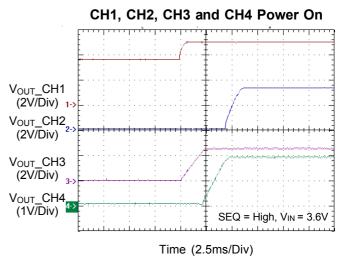


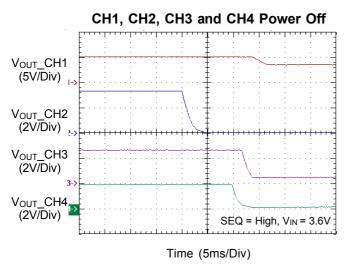


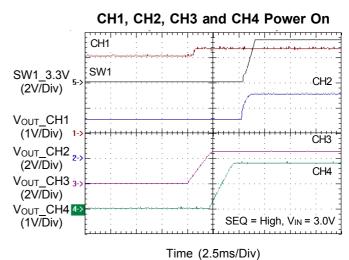


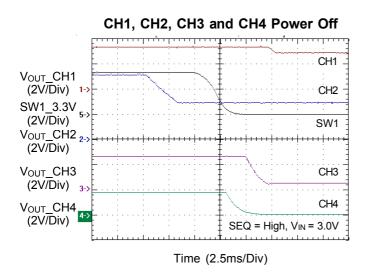


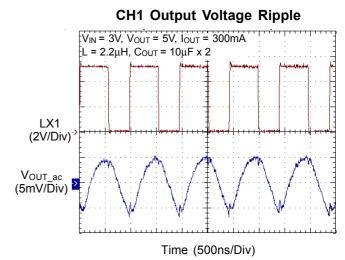




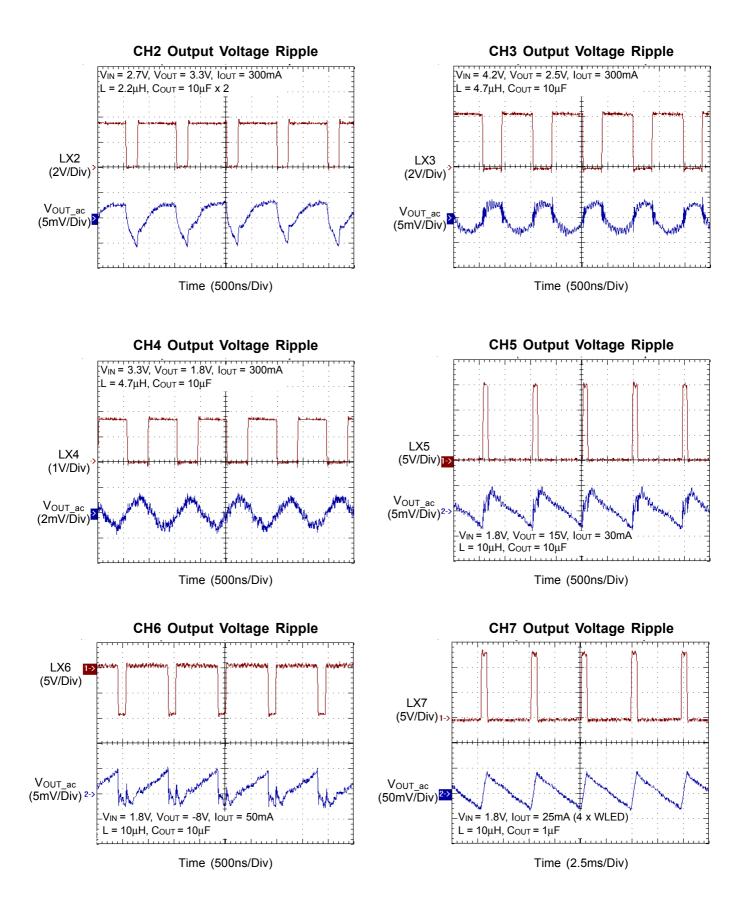




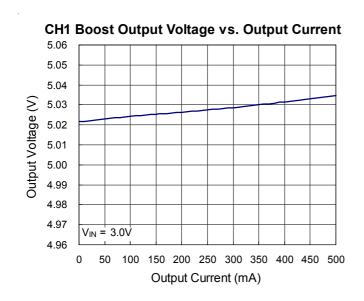


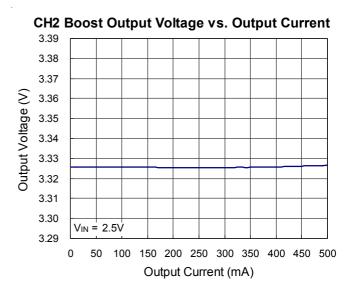


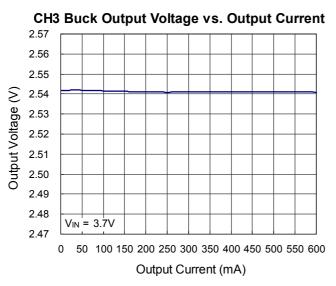


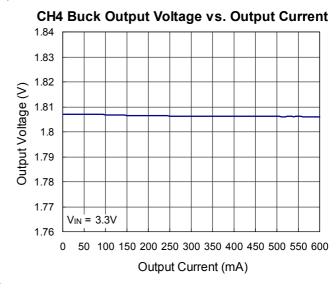


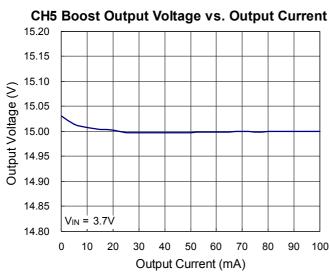


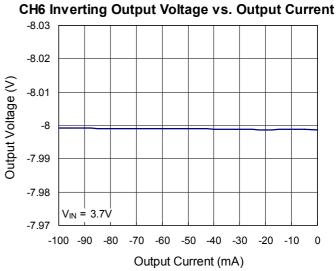












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Application information

The RT9917 includes the following seven DC/DC converter channels to build a multiple-output power-supply system.

- CH1: Step-up synchronous current mode DC/DC converter with internal power MOSFETs. The output voltage could be load disconnected by a switch controller and an external PMOS.
- CH2: Selectable step-up or step-down synchronous current mode DC/DC converter with internal power MOSFETs.
- CH3: Step-down synchronous current mode DC/DC converter with internal power MOSFETs and internal compensation network.
- CH4: Step-down synchronous current mode DC/DC converter with internal power MOSFETs and internal compensation network.
- CH5: Step-up asynchronous current mode DC/DC converter with internal power MOSFET and internal compensation network. The output voltage could be load disconnected by an internal PMOS.
- CH6: Inverting current mode DC/DC converter with internal power MOSFET.
- CH7: Current mode WLED driver with internal power MOSFET and internal compensation network. Also provides open LED protection.
- SW1: Load disconnect controller for CH1.
- SW5: Load disconnect switch for CH5

All converters operate in PWM mode with 1MHz constant frequency under moderate to heavy loading. The RT9917 also provides two different on/off sequences by setting "SEQ" pin.

CH1: Step-Up Converter

Step-up: The converter operates at fixed frequency PWM mode and continuous current mode (CCM) with internal MOSFET and synchronous rectifier for up to 95% efficiency.

Add a SBD between LX1 and PVDD1 for 2AA battery application.

CH2 : Selectable Step-Up or Step-Down Converter

Step-up: The converter operates at fixed frequency PWM mode and continuous current mode (CCM) with internal MOSFET and synchronous rectifier for up to 95% efficiency.

Step-down: The converter operates at fixed frequency PWM mode and continuous current mode (CCM) with internal MOSFET and synchronous rectifier for up to 95% efficiency. While the input voltage is close to the output voltage, the converter enters low dropout mode. The duty could be as long as 100% to extend battery life.

CH3: Step-Down DC/DC Converter

The converter operates at fixed frequency PWM mode, CCM and integrated internal compensation. While the input voltage is close to the output voltage, the converter could enter low dropout mode with low output ripple. The duty could be as long as 100% to extend the battery life.

CH4: Step-Down DC/DC Converter

The converter operates at fixed frequency PWM mode, CCM and integrated internal compensation. While the input voltage is close to the output voltage, the converter could enter low dropout mode with low output ripple. The duty could be as long as 100% to extend the battery life.

CH5: Step-Up DC/DC Converter

It integrates asynchronous boost with an internal MOSFET, internal compensation and an external schottky diode to provide CCD positive power supply. The converter is inactive until the SW5 soft start procedure is finished. This feature provides load disconnect function and effectively limits the inrush current at start up.

CH6: INV DC/DC Controller

This controller integrates an internal P-MOSFET and an external schottky diode to provide CCD negative power supply. The output voltage is set as

 V_{OUT} = (R10/R11) x (-1.25) (R10, R11 refer to Typical Application Circuit).



CH7: WLED Driver

It is an asynchronous DC/DC converter with an internal MOSFET, internal compensation and an external schottky diode to drive up to 4 WLED. This channel also features PWM dimming control from EN7 pin and open diode protection. The current through WLED is set as

 $I (mA) = [250mV/R(\Omega)] \times Duty (\%)$

R: Current sense resistor from CFB7 to GND.

Duty: PWM dimming by EN7 pin. Dimming frequency range is from 1kHz to 100kHz but it is recommended to avoid 2kHz to 20kHz for audio noise. Hold EN7 low for more than 15ms will turn off CH7.

SW1

SW1 is an open drain controller to drive an external PMOS and then functions as a load disconnect switch for CH1. This switch features soft start, Power On/Off Sequence and under voltage protection functions. OK134 is an open drain control pin. Once CH1, CH3 and CH4's soft start are completed, SW1 is on. The OK134 pin is slowly pulled low and controlled with soft start to suppress the inrush current. VOUT1 is used for SW1 soft start and under voltage protection. If SW1 is not used, connect a resistor to VOUT1 (Refer to Typical Application Circuit for Li-ion).

SW5

SW5 is an internal switch enabled by EN5 and functions as a load disconnection for CH5. This switch features soft start, Powe On Sequence, over voltage (for SW5I) and under voltage (for SW5O) protection functions.

Charge Pumps

The charge pump function is enabled while battery type is alkaline battery. This channel provides pump voltage to enhance MOS gate driving capability. This function is not necessary while battery is Li-ion type.

Reference Voltage

The RT9917 provides a precise 1.25V reference voltage with sourcing capability 100μA. Connect a 0.1μF ceramic capacitor from VREF pin to GND. Reference voltage is enabled by connecting EN6 to logic high. Furthermore, this reference voltage is internally pulled to GND in shutdown.

Mode and sequence setting

Please refer to "Electrical Characteristics" for level of logic high or low.

Table 1. Mode setting

SEL	CH2
High	Boost
Low	Buck

For CH2, Mode setting is decided by "SEL" pin. The CH2 of RT9917 features flexible boost or buck topology setting for either 1x Li-ion or 2 x AA application by one pin.

Table 2. Sequence setting

SEQ	Power ON Sequence
High	CH1 -> CH3 -> CH4 -> (SW1 and CH2)
Low	CH3 -> CH4 -> CH1 -> (SW1 and CH2)

SEQ	Power OFF Sequence
High	(SW1 and CH2) -> CH4 -> CH3 -> CH1
Low	(SW1 and CH2) -> CH1 -> CH4 -> CH3

Sequence setting is decided by "SEQ" pin.Please note that the logic state can not be changed during operation.

SEQ = High

The Power On Sequence is:

- ▶ While EN134 goes high, CH1 will be turned on to wait for the completion of CH1's soft start.
- ▶ After that, CH3 will be turned on to wait for the completion of CH3's soft start.
- ▶ And then, CH4 will be turned on to wait for the completion of CH4's soft start.
- ▶ Then, SW1 will be turned on and CH2 is allowed to be turned on by EN2 at any time.
- Finally, SW1's soft start will be completed.

The Power-Off Sequence is:

- ▶ At first, while EN134 goes low, (SW1 is showdown and internally pulled low, CH2 must be turned off by EN2) SW1 (note 1) and CH2 (note 2) will be shutdown.
- ▶ After that, CH4 will be turned off and internally pulled low to wait for the completion of CH4's shutdown.
- ▶ And then, CH3 will be turned off and internally pulled low to wait for CH3's shutdown completion.



- ▶ Then, CH1 will be turned off and internally pulled low (note 3) to wait for CH1's shutdown completion.
- ▶ Finally, the whole IC will be shutdown (if EN5, EN6 and EN7 already go low).
- Note 1: The SW1 is designed for CH1.
- Note 2: If CH2 is configured as a Boost, then the CH2 will not be internally pulled low and the completion of shutdown will not be checked.
- Note3: CH1 is configured as a Boost, so the CH1 will not be internally pulled low and the completion of shutdown will not be checked.

SEQ = Low

The Power On Sequence is:

- ▶ While EN134 goes high, CH3 will be turned on to wait for the completion of CH3's soft start.
- ▶ After that, CH4 will be be turned on to wait for the completion of CH4's soft start.
- ▶ And then, CH1 will be turned on to wait for the completion

of CH1's soft start.

- ▶ Then, SW1 will be turned on and CH2 is allowed to be turned on by EN2 at any time.
- ▶ Finally, SW1's soft start will be completed.

The Power-Off Sequence is:

- ▶ At first, while EN134 goes low, (SW1 is showdown and internally pulled low, CH2 must be turned off by EN2) SW1 (note 1) and CH2 (note 2) will be shutdown.
- ▶ Then, CH1 will be turned off and internally pulled low (note 3) to wait for CH1's shutdown completion.
- ▶ After that, CH4 will be turned off and internally pulled low to wait for the completion of CH4's shutdown.
- ▶ And then, CH3 will be turned off and internally pulled low to wait for CH3's shutdown completion.
- Finally, the whole IC will be shutdown (if EN5, EN6 and EN7 already go low).

Protection

	Protection type	Threshold (typical) Refer to Electrical spec	Protection methods	Reset method	
V_{DDM}	Over Voltage Protection		Disable all channels (except CH7)	Restart if V _{DDM} < 5.6V (with hysteresis)	
CH1:Boost	Current Limit	NMOS current> 3A	NMOS off, PMOS on	Automatic reset at next clock cycle	
	PVDD1 OVP	PVDD1 > 6V	IC shutdown (except CH7)	V _{DDM} power reset	
CH2:Boost	Current Limit	NMOS current> 3A	NMOS off, PMOS on	Automatic reset at next clock cycle	
	PVDD2 OVP	PVDD2 > 6V	IC shutdown (except CH7)	V _{DDM} power reset	
CH2:Buck	OCP	PMOS current > 1.5A	IC shutdown (except CH7)	V _{DDM} power reset	
CH3:Buck	OCP	PMOS current > 1.5A	IC shutdown (except CH7)	V _{DDM} power reset	
CH4:Buck	OCP	PMOS current > 1.5A	IC shutdown (except CH7)	V _{DDM} power reset	
CH5:	OCP	NMOS current > 1.5A	NMOS off	Automatic reset at next clock cycle	
CH6:	OCP	PMOS current > 1.5A	IC shutdown (except CH7)	V _{DDM} power reset	
CH7:WLED	OCP	NMOS current > 0.8A	NMOS off	Automatic reset at next clock cycle	
	OVP	VOUT7 > 19V	Shutdown CH7	Reset by toggling EN7	
SW1	UVP	VOUT1 < 1.75V after SW1 soft start end	IC shutdown (except CH7)	V _{DDM} power reset	
SW5	OVP	SW5I > 19V	IC shutdown (except CH7)	V _{DDM} power reset	
	UVP	SW5O < 0.4V after SW5 soft start end	IC shutdown (except CH7)	V _{DDM} power reset	
Thermal	Thermal shutdown	Temperature > 160°C	All channels stop switching	Temperature < 140°C	



Thermal Considerations

For continuous operation, do not exceed absolute maximum operation junction temperature. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

Where $T_{J(MAX)}$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

For recommended operating conditions specification, where $T_{J(MAX)}$ is the maximum junction temperature of the die (125°C) and T_A is the ambient temperature. The junction to ambient thermal resistance θ_{JA} is layout dependent. For WQFN-40L 5x5 packages, the thermal resistance θ_{JA} is 36°C/W on the standard JEDEC 51-7 four layers thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by following formula :

 $P_{D(MAX)}$ = (125°C - 25°C) / (36°C/W) = 2.778W for WQFN-40L 5x5 packages

The maximum power dissipation depends on operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance θ_{JA} . For RT9917 package, the Figure 1 of derating curves allows the designer to see the effect of rising ambient temperature on the maximum power allowed.

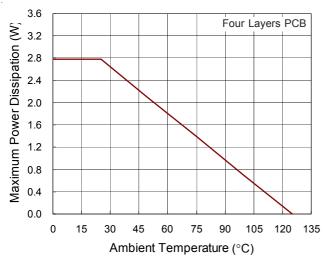


Figure 1. Derating Curves for RT9917 Packages

Layout Consideration

All the traces of the compensation components should be short to reduce the parasitic connection resistance and isolated from other noisy device traces. The ground traces must be connected to ground plane independently.

Compensative parts: R15, C16, R18, C19, R12, C11, C14.

▶ All the traces of the feedback components should be short to reduce the parasitic connection resistance and isolated from other noisy device traces. The ground traces must be connected to ground plane independently. Output sense trace must be kept away from the noisy device (inductor).

Feedback parts:

R13, R14, C15 for CH1. R16, R17, C18 for CH2. R3, R4, C4 for CH3.

R5, R6, C6 for CH4. R7, R8, C9 for CH5.

R10, R11, C13for CH6. R9 for CH7.

▶ All the traces of connecting inductor must be as wide as possible.

Inductor: L1, L2, L3, L4, L5, L6, L7.

▶ Output Capacitor should be placed close to Vout and connected to ground plane to reduce noise coupling.

Output capacitor: C1, C5, C7, C8, C10, C12, C17 and C24.

▶ Input capacitor should be placed close to Vbat and connected to ground plane.

Input capacitor: C2, C3, C20, C21, C26, C27 and C28.

- ▶ The GND (Pin 27) and Exposed Pad should be connected to a strong ground plane for heat sinking and noise protection.
- ➤ The EN7 pin is used for dimming control. Keep the FB3 trace away from the EN7.



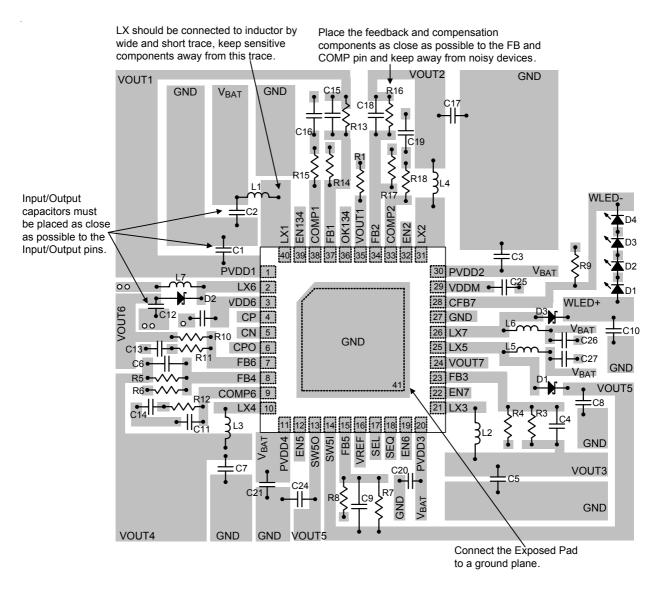
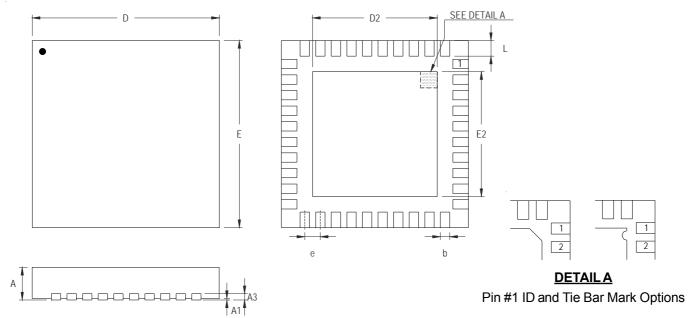


Figure 2



Outline Dimension



Note: The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Oh. a.l.	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
А	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.150	0.250	0.006	0.010
D	4.950	5.050	0.195	0.199
D2	3.250	3.500	0.128	0.138
Е	4.950	5.050	0.195	0.199
E2	3.250	3.500	0.128	0.138
е	0.400		0.016	
L	0.350	0.450	0.014	0.018

W-Type 40L QFN 5x5 Package

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